Preferred Device

Complementary Darlington Silicon Power Transistors

These devices are designed for use as general purpose amplifiers, low frequency switching and motor control applications.

Features

- High DC Current Gain @ 10 Adc h_{FE} = 400 Min (All Types)
- Collector-Emitter Sustaining Voltage

• Low Collector-Emitter Saturation Voltage

$$V_{CE(sat)} = 1.2 \text{ V (Typ)} @ I_C = 5.0 \text{ A}$$

= 1.8 V (Typ) @ $I_C = 10 \text{ A}$

- Monolithic Construction
- Pb-Free Packages are Available*

MAXIMUM RATINGS mbəl Max Collector-Emitter Voltage V_{CEO} MJH11018, MJH11017 MJH11020, MJH11019 200 250 MJH11022, MJH11021 Collector-Base Voltage $V_{\text{CB}} \\$ Vdc MJH11018, MJH11017 150 MJH11020, MJH11019 200 MJH11022, MJH11021 250 Emitter-Base Voltage 5.0 Vdc V_{EB} Collector Current Continuous 15 Adc I_{C} - Peak (Note 1) 30 Base Current I_B 0.5 Adc Total Device Dissipation @ T_C = 25°C P_D 150 \٨/ Derate above 25°C 1.2 W/°C Operating and Storage Junction Temperature °C T_J, T_{sta} -65 to +150

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit	
Thermal Resistance, Junction-to-Case	$R_{\theta,IC}$	0.83	°C/W	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle ≤ 10%.

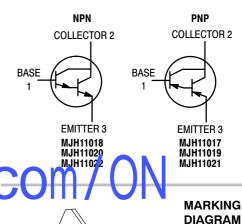
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

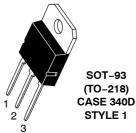


ON Semiconductor®

http://onsemi.com

15 AMPERE DARLINGTON COMPLEMENTARY SILICON POWER TRANSISTORS 150-250 VOLTS, 150 WATTS







A = Assembly Location

Y = Year

WW = Work Week

G = Pb-Free Package

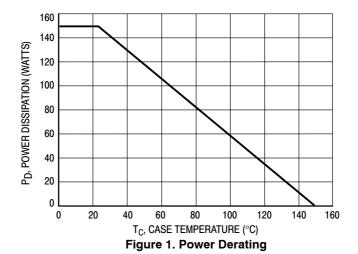
MJH110xx = Device Code

xx = 17, 19, 21, 18, 20, 22

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.



ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic			Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (Note 2) (I _C = 0.1 Adc, I _B = 0)	MJH11017, MJH11018 MJH11019, MJH11020 MJH11021, MJH11022	V _{CEO(sus)}	150 200 250	- - -	Vdc
Collector Cutoff Current $(V_{CE} = 75 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 100 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 125 \text{ Vdc}, I_B = 0)$	MJH11017, MJH11018 MJH11019, MJH11020 MJH11021, MJH11022	I _{CEO}	- - -	1.0 1.0 1.0	mAdc
Collector Cutoff Current (V _{CE} = Rated V _{CE} , V _{3F(of)} + 1.5 Vdc) (V _{CE} = Rated V _{CE} , V _{3F(of)} + 1.5 Vdc, T _J =	DTIC.CO) ICEV	01	0.5 5.0	mAdc
Emitter Cutoff Current ($V_{BE} = 5.0 \text{ Vdc } I_{C} = 0$)		I _{EBO}	-	2.0	mAdc
ON CHARACTERISTICS (Note 2)					
DC Current Gain ($I_C = 10$ Adc, $V_{CE} = 5.0$ Vdc) ($I_C = 15$ Adc, $V_{CE} = 5.0$ Vdc)		h _{FE}	400 100	15,000	-
Collector–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 100$ mA) ($I_C = 15$ Adc, $I_B = 150$ mA)		V _{CE(sat)}	- -	2.5 4.0	Vdc
Base–Emitter On Voltage (I _C = 10 A, V _{CE} = 5.0 Vdc)			-	2.8	Vdc
Base–Emitter Saturation Voltage (I _C = 15 Adc, I _B = 150 mA)		V _{BE(sat)}	-	3.8	Vdc
DYNAMIC CHARACTERISTICS					
Current-Gain Bandwidth Product (I _C = 10 Adc, V _{CE} = 3.0 Vdc, f = 1.0 MHz)		f _T	3.0	-	-
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	MJH11018, MJH11020, MJH11022 0, f = 0.1 MHz) MJH11019, MJH11021		- -	400 600	pF
0 "0" 10 10 11 11					

SWITCHING CHARACTERISTICS

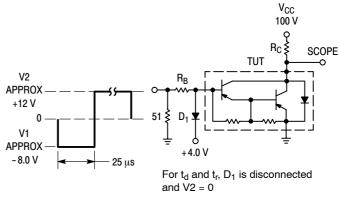
			Typical		
Characteristic		Symbol	NPN	PNP	Unit
Delay Time		t _d	150	75	ns
Rise Time	$(V_{CC} = 100 \text{ V}, I_{C} = 10 \text{ A}, I_{B} = 100 \text{ mA} $ $V_{BE(off)} = 5.0 \text{ V}) \text{ (See Figure 2)}$	t _r	1.2	0.5	μs
Storage Time		t _s	4.4	2.7	μs
Fall Time		t _f	2.5	2.5	μs

 h_{fe}

Small-Signal Current Gain ($I_C = 10$ Adc, $V_{CE} = 3.0$ Vdc, f = 1.0 kHz)

^{2.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

R_B & R_C varied to obtain desired current levels D₁, must be fast recovery types, e.g.: 1N5825 used above I_B \approx 100 mA MSD6100 used below I_B \approx 100 mA



 t_r , $t_f \le 10 \text{ ns}$ Duty Cycle = 1.0%

For NPN test circuit, reverse diode and voltage polarities.

Figure 2. Switching Times Test Circuit

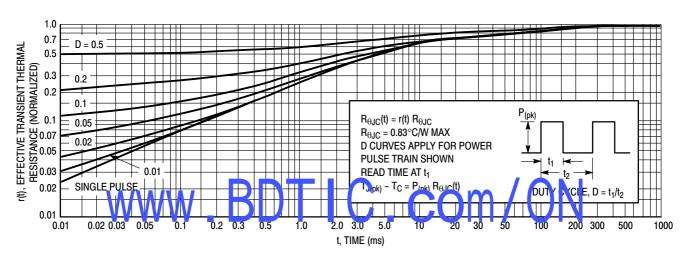


Figure 3. Thermal Response

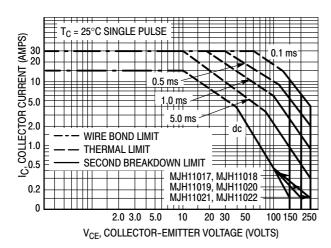


Figure 4. Maximum Rated Forward Bias Safe Operating Area (FBSOA)

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 4 is based on $T_{J(pk)} = 150^{\circ}\text{C}$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150^{\circ}\text{C}$. $T_{J(pk)}$ may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

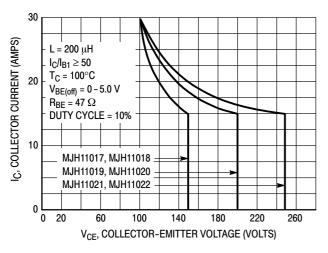


Figure 5. Maximum Rated Reverse Bias Safe Operating Area (RBSOA)

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 5 gives RBSOA characteristics.

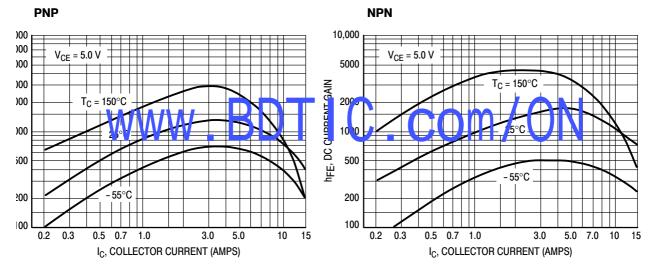


Figure 6. DC Current Gain

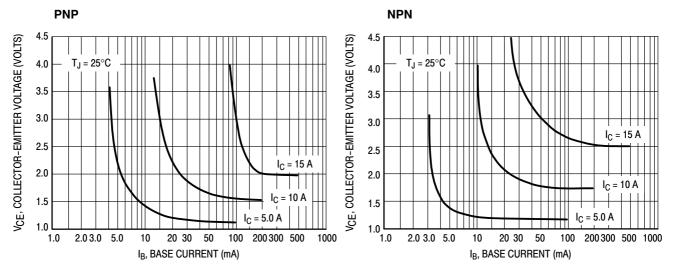


Figure 7. Collector Saturation Region

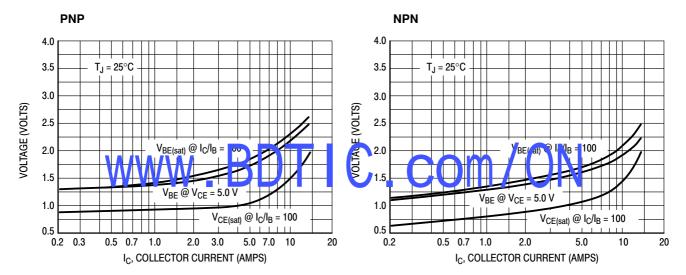


Figure 8. "On" Voltages

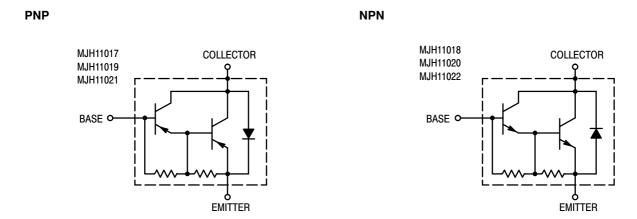


Figure 9. Darlington Schematic

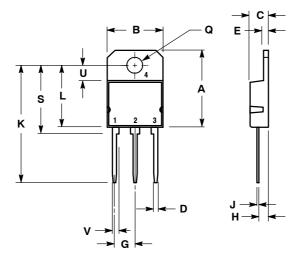
ORDERING INFORMATION

Device Order Number	Package Type	Shipping
MJH11017	SOT-93	30 Units / Rail
MJH11017G	SOT-93 (Pb-Free)	30 Units / Rail
MJH11018	SOT-93	30 Units / Rail
MJH11018G	SOT-93 (Pb-Free)	30 Units / Rail
MJH11019	SOT-93	30 Units / Rail
MJH11019G	SOT-93 (Pb-Free)	30 Units / Rail
MJH11020	SOT-93	30 Units / Rail
MJH11020G	SOT-93 (Pb-Free)	30 Units / Rail
MJH11021	SOT-93	30 Units / Rail
MJH11021G	SOT-93 (Pb-Free)	30 Units / Rail
MJH11022	SOT-93	30 Units / Rail
MJH11022G	SOT-93 (Pb-Free)	30 Units / Rail

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PACKAGE DIMENSIONS

SOT-93 (TO-218) CASE 340D-02 ISSUE E



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α		20.35		0.801
В	14.70	15.20	0.579	0.598
С	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
E	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
Н	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00 REF		1.220 REF	
L		16.20		0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00	4.00 REF 0.157 REF		REF
V	1 75	RFF	0.069	

STYLE 1:

- N 1 BASE
- 2. COLLECTOR
- 3. EMITTER
- 4 COLLECTOR

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